

12 A Three-quadrant triacs high commutation Rev. 01 — 11 April 2007

Product data sheet

Product profile 1.

1.1 General description

Passivated, new generation, high commutation triacs in a SOT186A full pack plastic package

1.2 Features

- Very high commutation performance maximized at each gate sensitivity
- High isolation voltage

1.3 Applications

- High power motor control e.g. washing Refrigeration and air conditioning machines, vacuum cleaners
- Non-linear rectifier-fed motor loads

1.4 Quick reference data

- V_{DRM} ≤ 600 V (BTA312X-600B/C)
- V_{DRM} \leq 800 V (BTA312X-800B)
- I_{TSM} \leq 95 A (t = 20 ms)

- compressors
- Electronic thermostats

High immunity to dV/dt

- I_{GT} \leq 50 mA (BTA312X-series B)
- I_{GT} ≤ 35 mA (BTA312X-600C)
- I $I_{T(RMS)} \le 12 \text{ A}$

SOT186A (TO-220F)

Pinning information 2.

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		N 1
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)		`G sym051
mb	mounting base; isolated		



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3. Ordering information

Table 2. Ordering information							
Type number	Package	ackage					
	Name	Description	Version				
BTA312X-600B	TO-220F						
BTA312X-600C		3-lead TO-220 'full pack'					
BTA312X-800B							

4. Limiting values

Table 3.Limiting values

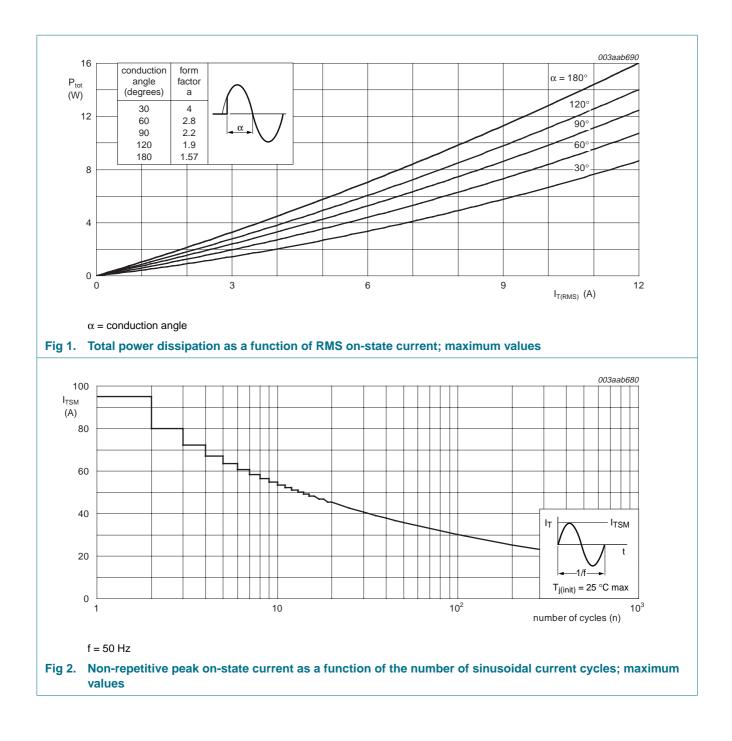
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA312X-600B; BTA312X-600C	<u>[1]</u> -	600	V
		BTA312X-800B	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _h ≤ 61 °C; see <u>Figure 4</u> and <u>5</u>	-	12	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	95	А
		t = 16.7 ms	-	105	А
l ² t	I ² t for fusing	t = 10 ms	-	45	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
T _i	junction temperature		-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

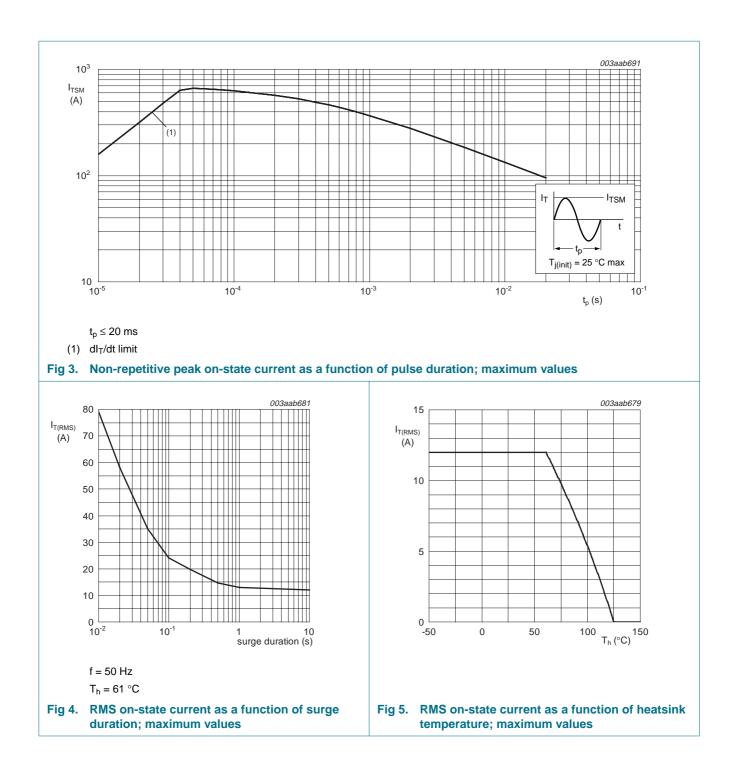
BTA312X series B and C

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BTA312X series B and C

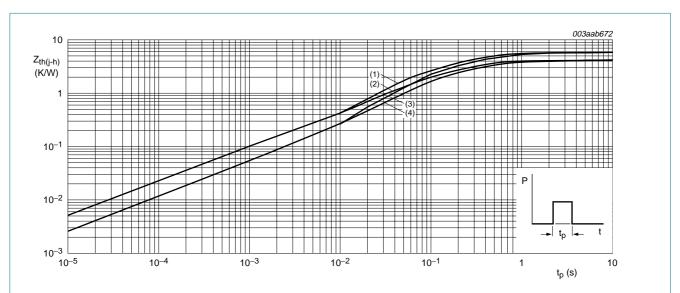
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	full or half cycle; without heatsink compound; see Figure 6	-	-	5.5	K/W
		full or half cycle; with heatsink compound; see Figure 6	-	-	4.0	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	55	-	K/W



(1) Unidirectional (half cycle) without heatsink compound

(2) Unidirectional (half cycle) with heatsink compound

(3) Bidirectional (full cycle) without heatsink compound

(4) Bidirectional (full cycle) with heatsink compound

Fig 6. Transient thermal impedance from junction to heatsink as a function of pulse duration

6. Isolation characteristics

Table 5.Isolation limiting values and characteristics $T_b = 25 \degree C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from pin 2 to external heatsink; f = 1 MHz	-	10	-	pF

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7. Static characteristics

Table 6. Static characteristics

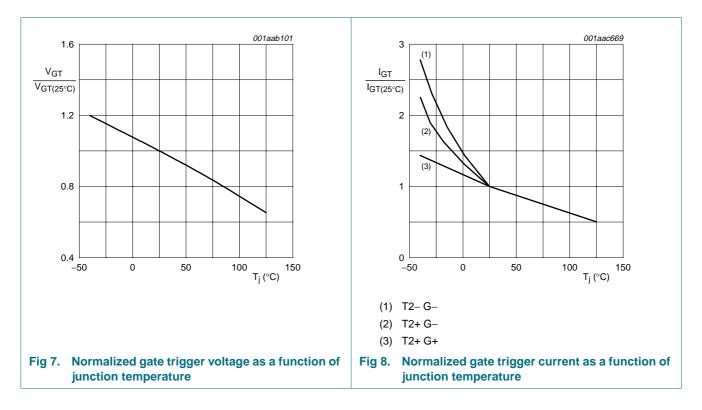
 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		BTA312X-600B BTA312X-800B			BTA312X-600C		
				Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$							
	current	T2+ G+	2	-	50	2	-	35	mA
		T2+ G-	2	-	50	2	-	35	mA
		T2- G-	2	-	50	2	-	35	mA
IL	L latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } Figure 10$							
		T2+ G+	-	-	60	-	-	50	mA
		T2+ G-	-	-	90	-	-	60	mA
		T2– G–	-	-	60	-	-	50	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } Figure 11$	-	-	60	-	-	35	mA
V _T	on-state voltage	I _T = 15 A; see <u>Figure 9</u>	-	1.3	1.6	-	1.3	1.6	V
V _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.8	1.5	-	0.8	1.5	V
	voltage	$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \ ^\circ\text{C}$	0.25	0.4	-	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA

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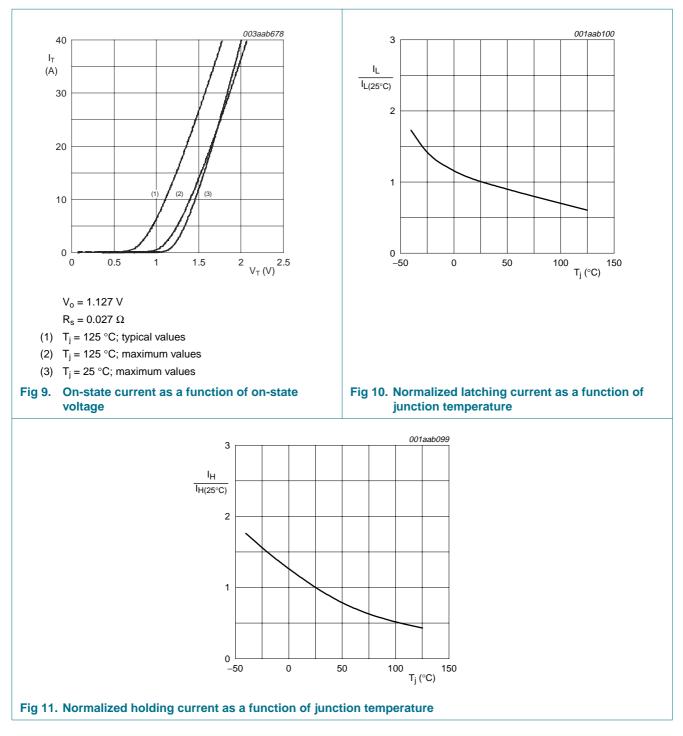
8. Dynamic characteristics

Symbol Parameter		Conditions	BTA312X-600B BTA312X-800B			BTA312X-600C			Unit
			Min	Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 0.67 × $V_{DRM(max)}$; T_j = 125 °C; exponential waveform; gate open circuit	1000	2000	-	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_{DM} = 400 V; T_{j} = 125 °C; $I_{T(RMS)}$ = 12 A; without snubber; gate open circuit	30	-	-	20	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A}; \\ dI_G/dt &= 5 A/\mu s \end{split}$	-	2	-	-	2	-	μs



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9. Package information

Epoxy meets UL94 V-0 at 3.175 mm.

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10. Package outline

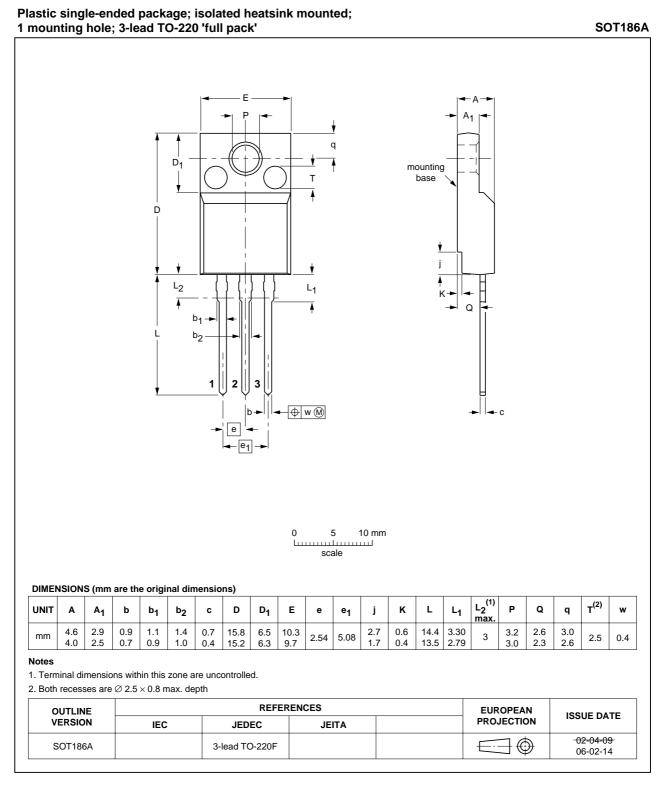


Fig 12. Package outline SOT186A (3-lead TO-220F)

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11. Revision history

Table 8. Revision hist	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BTA312X_SER_B_C_1	20070411	Product data sheet	-	-	

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12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 11 April 2007 Document identifier: BTA312X_SER_B_C_1

